STATUS OF MICROMEGAS DHCAL CALICE Collaboration Meeting - Lyon

Ambroise Espargilière

LAPP, Annecy

September 18, 2009

Outline

1 Engineering Developments

Electronics Developments

- Detector InterFace (DIF)
- DIRAC ASICs Characterization and New Developments

Simulation Activities

- MICROMEGAS Developments for DHCAL Active Layer
 - Electronics and acquisition
 - Analysis Framework
 - $\bullet \ \mathrm{MICROMEGAS}$ prototypes performances
 - Shower measurements
 - Tests with digital electronics
 - Square Meter Project

Conclusion

Engineering Developments

Ambroise Espargilière (LAPP, Annecy) STATUS OF MICROMEGAS DHCAL

SID DHCAL Mechanical Design

SiD HCAL:

- Designed at LAPP (N. Geffroy)
- Taken as a baseline in SiD LOI
- Detailed design needed
- Deeper study foreseen at LAPP (N. Geffroy)
- \Rightarrow Construction of a module 0



ELECTRONICS DEVELOPMENTS

Detector InterFace (DIF)

Calice DAQ Scheme:



 $DIF \iff$ front-end electronics: data transfer, very front-end chip control

Detector InterFace (DIF)

- Fully Designed at LAPP (J. Prast, S. Cap)
- First intermediate board between ASU and DAQ
- Programmable via VHDL code
- VHDL code implemented at LAPP (G. Vouters)
- Many firmwares available (see C. Drancourt's talk)
- Used in 2008 and 2009 Eu-DHCAL beam tests: MICROMEGAS and RPC



- DIRAC initially developed at IPNL
- Now in tight collaboration with LAPP
- DIRAC2 intensively tested at LAPP
- Best Power pulsing performance (stable at 2.7 μs power-on time)
- Very low threshold achievable ($< 10 \, {\rm fC?}$)
- First digital ASIC embedded on a bulk MICROMEGAS: tested successfully in 2008 beam test
- $\bullet~{\rm DIRAC2}~m^2$ foreseen for 2010

SIMULATION ACTIVITIES

- Cubic Meter Simulation (Jan Blaha's talk):
 - Better understanding of DHCAL generally
 - The first qualitative view on DHCAL global performance
 - Study performed:
 - Study of the main calorimeter characteristics
 - Comparison of various absorber materials: Fe, W, Pb
 - Comparison of analog and digital readout
 - Dependency on the readout threshold
- High Energy Physics Simulation (J. J. Blaising's talk)

MICROMEGAS DEVELOPMENTS FOR DHCAL ACTIVE LAYER



ELECTRONICS AND ACQUISITION DAQ

CENTAURE

- Developed by D. Roy (SUBATECH, Nantes)
- GASSIPLEX readout (any number of boards)
- Mesh readout



Labview

- Home made software for calibration
- Works for HARDROC1, HARDROC2 and DIRAC chips
- Development for cosmic data acquisition ongoing



X-DAQ

- Developed at IPNL
- Used for fast data acquisition
- Works for HARDROC1 and 2
- Development for DIRAC ongoing

Aspects

- Fast running
- html control interface
- Many annex files (xml, cfg)
- Not user friendly

Analysis Framework



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MICROMEGAS prototypes performances Specificities

Beam test 2008 Results

- Overall gain disparity $\approx 11\%$ $(384 \, {\rm cm}^2)$
- Efficiency = 97% at $1.5 \,\mathrm{fC}$
- Maximum Multiplicity < 1.1 at $1.5\,\mathrm{fC}$

General Features

- Robustness, industry process
- Low voltage (V_{mesh} & V_{drift} $< 500 \, {\rm V}$)
- Needs for low noise electronics
- Needs for reliable sparks protection

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Efficienc

0.8

0.6

0.2

Multiplicity 0.1

1.07

1.06

1.05

1.03



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Threshold (fC)

- CH1

CH3

120

- Two-week long data acquisition
- $\bullet~5.9\,\rm keV$ photons from $^{55}{\rm Fe}$
- Dependency of response versus *P* and *T*
- Method for gain correction established:

$$f_x = 1 - C_x \cdot \Delta(x)$$



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Shower measurements

(see M. Chefdeville's talk...)

- Micromegas behaviour in 2 GeV electron:
 - Stable and high gain during test period (a few HV trips over 12 days)
 - P,T variations can be corrected for, or HV adjusted accordingly
- Energy and number of hit distributions:
 - Show a similar trend with the number of absorber
 - Longitudinal hit distribution maximum reached slightly deeper
 - Transverse hit distribution shows larger RMS at first shower stages

Future plans

- Comparison with simulation
- Take data at different energies at next beam test (next week)



First DIRAC operative test (Beam test 2008, August)

- Single ASIC 8×8 pad MICROMEGAS chamber
- Very first test of bulk MICROMEGAS with embedded digital readout
- fully successful
- Raw multiplicity of 1.1



Figure: Beam profile obtained with digital readout using the DIRAC ASIC.

First HARDROC1 operative test on MICROMEGAS (Beam test 2009, May)

- Beam profile observed w and w/o scintillator coincidence
- Lack of support for X-DAQ before beam test
- Raw efficiency estimated above 60%



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Ongoing tests of $\operatorname{MICROMEGAS}$ $\operatorname{HARDROC1}$ at LAPP

Calibration

- LabVIEW software
- All S-curves processed (calibration constants almost ready)
- HARDROC1 with optimum configuration should be ready for next week beam test

Cosmic tests

- X-DAQ up to date
- Scintillator trigger
- Iow rate
- calibration constants not applied yet

Square Meter Project Layout



Square Meter Project Layout



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Square Meter Project Test Box

- Every ASU has to be tested individually:
 - Electronics verifications
 - Mesh cooking
 - Get physical signal from the pads (⁵⁵Fe source and/or cosmics)
- Clean room available for handling naked mesh ASU
- A test box has been built:
 - ASU easily inserted and removed
 - Plexiglass lid for mesh cooking
 - Aluminum lid, drilled above every pad for X-rays injection
 - Drift cathode on the aluminum lid
 ⇒ 3 cm drift gap
 - A fully functional MICROMEGAS test chamber





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Square Meter Project Test Box

First tests of $\operatorname{MICROMEGAS}$ HARDROC2 at LAPP

- Two $32 \times 48 \text{ pad ASU}$
- 24 HARDROC2 chip each
- To be mounted inside the m² physics prototype



Figure: Response of a $32 \times 48 \text{ pad}$ ASU after irradiation with an ^{55}Fe source

Square Meter Project

Mechanical Prototype

A usefull model

- Test various assembly possibilities on small samples
- Establish an assembly process
- Train on building a prototype w/o real ASUs
- Perform mechanical tests
- Verify gas tightness



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- Physics m² assembly to begin on next Monday



CONCLUSION

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- SiD DHCAL Architecture (LOI)
- DIF boards + VHDL firmware
- DIRAC promising developments
- Productive simulation activities
- \bullet Developments of $\mathrm{MICROMEGAS}$ chamber as an active layer for DHCAL
 - Collaboration with CERN (bulk MICROMEGAS) and Saclay (Beam tests ...)
 - Building thin and large area chambers
 - Test various readout chips (HARDROC, DIRAC)
 - Very good progress toward a technical prototype (m², Eu-DHCAL m³)